No. P-JAJNJAKN-E002 DATE 2023-09

PRODUCTS DATA SHEET

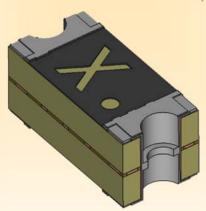
MICRO FUSE

Type JAJN, JAKN

Size 3.2 mm x 1.6 mm

Conforms to AEC-Q200 Table.7

UL. cUL Recognized
ROHS directive compliant product <ROHS COMPLIANT LEAD FREE>
Applied for a structural patent



JAJ type and JAK type high-reliability products suitable for automotive electronic de vices such as vehicle control devices.

It is a *1 compact and *2 product that supports high current and can be used as circu it protection against overcurrent in automotive and industrial equipment.

*1 Size 3.2 mm x 1.6 mm

*2 Maximum rated current 20A Fusing characteristics 60VDC, 100A



MATSUO ELECTRIC CO., LTD.

FEATURES

- 1. Rated current of 20A, rated voltage of 60VDC, and rated breaking current of 100A achieved in spite of its compact size of 3.2x1.6x1.4mm by our original structure.
- 2. Fast-acting type fuse with little variation in fusing characteristics.
- 3. Performance against rush current is excellent since plate material is used for fuse element.
- 4. Surface temperature rise is 75°C or less when applying rated current for fusing. This gives less influence to the peripheral units.
- 5. Resistance to soldering heat: Reflow or flow soldering 10 seconds at 260 °C.
- 6. Our original terminal construction makes almost no occurrence of Tombstone phenomenon.
- 7. Suitable for automatic mounting
- 8. Precise dimensions allows high-density mounting and symmetrical construction of terminals provide "Self-Alignment".
- 9. Complete lead-free, bromine-free.



CLEARING CHARACTERISTICS

| Rated Voltage | Breaking Current |
|---------------|------------------|
| 60 VDC | 100 A |

CERTIFICATION

| | Confor | ms to AEC-Q2 | 00 Table.7 |
|--|--------|--------------|------------|
|--|--------|--------------|------------|

| Certification Body | File No. | Range of Rated Current |
|--------------------|----------|------------------------|
| UL.cUL Recognized | E170721 | 10 A \sim 20 A |

CATEGORY TEMPERATURE RANGE

-40 °C ∼ +125 °C

INSULATION RESISTANCE

1 MΩ (between terminals and case)

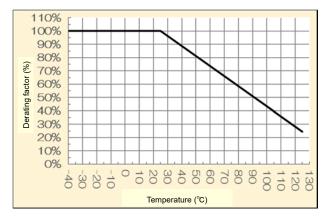
VOLTAGE DROP

| Type JAJ | Type JAK |
|----------|----------|
| 99 mV | 83 mV |

DERATING (REFERENCE DATA)

Steady current flowing through the fuse must be reduced by the ambient temperature.

> Assuming that rated current value is 100% Derating

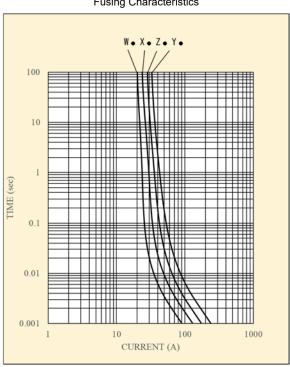


FUSING CHARACTERISTICS

| Туре | % of current rating | Time |
|-----------|---------------------|-----------------------------|
| T 1A INI | 100 % | Not fusing more than 1 hour |
| Type JAJN | 200 % | Fusing within 1 minute |
| T (A)(A) | 100 % | Not fusing more than 1 hour |
| Type JAKN | 250 % | Fusing within 1 minute |

FUSING CHARACTERISTICS (REFERENCE DATA)

Fusing Characteristics



MARKING

| Code | Type JAJ Rated Current | Type JAK Rated Current |
|------|------------------------|------------------------|
| w. | 12.5 A | 10 A |
| х. | 16 A | 12.5 A |
| Ζ. | | 16 A |
| Υ. | | 20 A |

CATALOG NUMBERS AND RATING

Type JAJN (200% fused product)

| Marking Code | Catalog number | Rated current | Resistance (Reference) |
|-----------------|------------------|---------------|---------------------------|
| w. | JAJN6002133 NA52 | 12.5 A | 4.59 mΩ |
| х. | JAJN6002163 NA52 | 16 A | 3.64 mΩ |

Type JAKN (250% fused product)

| Marking Code | Catalog number | Rated current | Resistance (Reference) |
|-----------------|------------------|---------------|---------------------------|
| w. | JAKN6002103 NA52 | 10 A | 4.59 mΩ |
| х. | JAKN6002133 NA52 | 12.5 A | 3.64 mΩ |
| Z. | JAKN6002163 NA52 | 16 A | 2.98 mΩ |
| Υ. | JAKN6002203 NA52 | 20 A | 2.40 mΩ |

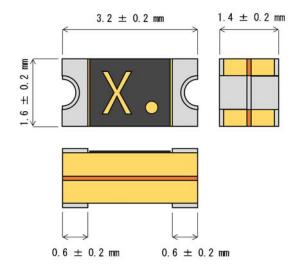
Type JAJN and type JAKN with the same rating marking code have exactly the same dimension, structure, and performance, and the only difference is the rating marking on the label.

ORDERING INFORMATION

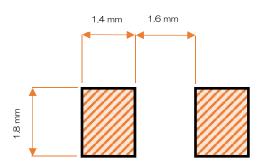
| J | Α | J | N | 6 | 0 | 0 | 2 | 1 | 6 | 3 | | 1 | 1 | Α | 5 | 2 |
|-----|----------------------------------|---|--------------|---|----------------|---|---|--------------|---|--------|----|--------|---------|----|---------|-----|
| | 1 | | 2 | | 3 |) | | | 4 | | (5 |) | 6 | | 7 |) |
| Fus | ①Type sin Characteristics : Type | | ②Series N | | 3Rated 60V: | · | (| Rated cur | | ⑤Blank | | ⑥Packa | age Coo | de | ⑦Case C | ode |
| | 200% : JA. 250% : JAk | | | | | | | 12.5A 16A | | | _ | | | | | |

20A: 203

DIMENSIONS

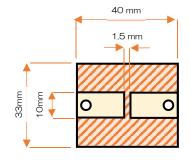


RECOMMENDED PAD DIMENSIONS



Please refer to the performance below for the temperature conditions of soldering.

STANDARD TEST BODY

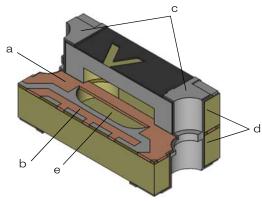


Glass epoxy body on one side Board thickness 1.6mm Copper layer 70µm

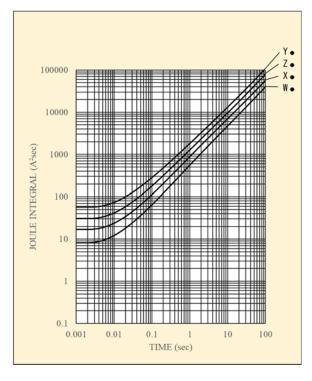
CONSTRUCTION

I²t – t CHARACTERISTICS (REFERENCE DATA)

I2t - t Characteristics



| Code | Parts | Material |
|------|------------|--|
| а | Fuse frame | Copper |
| b | Tiebar | Copper |
| С | Terminal | Copper foil, copper / nickel / tin plating |



APPLICATION CLASSIFICATION BY USE

Glass epoxy

Exterior

Space

The application classification by use which divided the market and use into four is set up supposing our products being used for a broad use.

Please confirm the application classification by use of each product that you intend to use.

Moreover, please be sure to inform to our Sales Department in advance in examination of the use of those other than the indicated use.

PERFORMANCE

| Item | Performance | Test method |
|-------------------------|---|---|
| Temperature rise | Temperature rise shall not exceed 75°C. | Apply rated current. |
| Current-carrying | Shall not open within 1 hour. | Apply rated current. |
| capacity | , , , , , , , , , , , , , , , , , , , | , |
| Clearing | Marking shall be legible. | 60VDC, 100A |
| characteristics | Shall not ignite, shall not explode the exterior | |
| Voltage drop | Type JAJ: 99mV, Type JAK: 83mV | Apply rated current. |
| | Fusing within 1 min. | Ambient temperature : 10 ~ 30°C |
| Fusing characteristics | | Type JAJ: Apply 200% of rated current. |
| | | Type JAK: Apply 250% of rated current. |
| Insulation resistance | 1 MΩ or more | Insulation resistance between terminals and case |
| | No mechanical damage. | Board supporting width : 90 mm |
| Electrode strength | Resistance change after the test shall be within \pm 20%. | Bending: 3 mm Bending speed: Approx. 0.5 mm/sec. |
| (Bending) | | Duration : 60±5 sec. |
| Electrode strength | There is no peeling between the terminal and the substrate. | Applied force: 17.7 N |
| (Shear test) | Resistance change after the test shall be within \pm 20%. | Duration : 10 sec. |
| | | Tool : R0.5 Pressurize from the side of the product |
| | No mechanical damage. | Supporting dimension: 1.6 mm |
| Substrate bending | Resistance change after the test shall be within \pm 20%. | Applied force : 20 N |
| test | | Duration: 10 sec. Tool: R0.5 |
| | | Direction of the press : thickness direction of product |
| | Solder Wetting time : within 3sec. | Solder : Sn-3Ag-0.5Cu |
| 0.11137 | | Temperature : 245±3°C |
| Solderability | | meniscograph method |
| (Solder Wetting time) | | Solder: JISZ3282 H60A,H60S,H63A Temperature: 230±2°C |
| | | meniscograph method |
| | The dipping surface of the terminals shall be covered more than | Solder : Sn-3Ag-0.5Cu |
| Solderability | 95% with new solder. | Temperature : 245±3°C Dipping : 3 sec. |
| (new uniform coating of | | Solder: JISZ3282 H60A,H60S,H63A |
| solder) | | Temperature : 230±2°C |
| | | Dipping : 3 sec. |
| | Marking shall be legible. | Measure after 1 hour left under room temperature and humidity. |
| | No mechanical damage. | After soldering, leave it in normal temperature and humidity for 1 hour or more, |
| | Resistance change after the test shall be within \pm 20%. | and measure the resistance value. |
| | | <soldering conditions=""></soldering> |
| | | Dipping (1 cycle) Preconditioning: 100~150°C / 60±5s |
| Resistance to | | Temperature: 265±3°C / 6~7s. |
| soldering heat | | Reflow soldering (2 cycles) |
| | | Preconditioning : 1∼2min 180°C or less Peak : max 250±5°C 5s |
| | | Holding: 230~250°C 30~40s |
| | | Cooling : more than 2min |
| | | Manual soldering |
| | | Temperature : 350±10°C Duration : 3∼4s |
| Vibration | No mechanical damage. | Vibration amplitude: 5G (49m/s²) , Vibration time: 20min |
| | Resistance change after the test shall be within \pm 20%. | Frequency range: 10~2000Hz |
| | | Number of cycles: 12 cycles each in 3 directions of XYZ (36 in total) |
| Shock | No mechanical damage. | Peak acceleration: 1500G (14700m/s²) |
| | Resistance change after the test shall be within \pm 20%. | Duration: 0.5ms, Wave form: Half-sine, Speed change: 4.7m/s |
| | | 6 sides x 3 times (18 times in total) |
| Temperature cycle | No mechanical damage. | Perform 1000 cycles, with steps 1 and 2 below as one cycle. The transition |
| | Resistance change after the test shall be within \pm 20%. | time between stage 1 and stage 2 shall be within 3 min. |
| | | Step1:-55°C±3°C/30±3min |
| | | Step2: 125±2°C/30±3min |
| | No mechanical damage. | Temperature: 85±3°C |
| Moisture resistance | Resistance change after the test shall be within \pm 20%. | Humidity: 85±5%RH |
| | N No mechanical damage | Duration : 1000 h Temperature : 85±2°C, Current : rated current × 70%, Duration : 1000 h |
| Load life | N No mechanical damage. Resistance change after the test shall be within \pm 20%. | Temperature : 65±2°C, Current : rated current × 70%, Duration : 1000 h Temperature : 125±2°C, Current : rated current × 60%, Duration : 1000 h |
| | No mechanical damage. | Temperature: 85±3°C |
| Moisture resistance | Resistance change after the test shall be within \pm 20%. | Humidity: 85±5%RH |
| load | | Current : rated current × 70% |
| | | Duration : 1000 h |
| High temperature | No mechanical damage. | Temperature : 125±2°C No electricity, |
| exposure | Resistance change after the test shall be within \pm 20%. | Duration : 1000 h |
| (Stability) | | |
| Solvent resistance | Marking shall be legible. | Dipping rinse Solvent : Isopropyl alcohol |
| | No damage to the appearance. | Duration : 90 sec. |
| | The resistance value after the test must be within ± 20% of the | |
| | resistance value before the test. | |
| | | FOR LIDM six six Pd Olobar C 1 450 5 |
| ESD resistance | No mechanical damage. Resistance change after the test shall be within ± 20%. | ESD-HBM circuit Rd=2kOhm, Cd=150pF Withstand voltage: 4000 - 6000V by contact discharge |

| Item | Performance | Test method |
|-------------------|---|--|
| High and Low Temp | No mechanical damage, and the resistance value cleared the following standard. (1) Step 1 (20±2°C): Initial resistance value (2) Step 2 (-40±3°C): Within -17% to +3% of Step 1 result (3) Step 3 (20±2°C): Within ±5% of Step 1 result (4) Step 4 (85±2°C): Within -3% to +17% of Step 1 result (5) Step 5 (125±2°C): Within +2% to +22% of Step 1 result (6) Step 6 (20±2°C): Within ±5% of Step 1 result | (1) Step 1 (20±2°C) (2) Step 2 (40±3°C) (3) Step 3 (20±2°C) (4) Step 4 (85±2°C) (5) Step 5 (125±2°C) (6) Step 6 (20±2°C) In order from (1) to (6), changing the temp and measuring the resistane charge. |



Application Notes for Micro Fuse

Micro Fuse should be designated only after confirming operating conditions and Micro Fuse performance characteristics.

When determining the rated current, be sure to observe the following items:

- (1) Micro Fuse should always be operated below the rated current (the value considered in the temperature derating rate) and voltage specifications.
- (2) Micro Fuse should always be operated below the rated voltage.
- (3) Micro Fuse should be selected with correct rated value to be fused at overload current.
- (4) When Micro Fuse are used in inrush current applications, please confirm sufficiently inrush resistance of Micro Fuse.
- (5) Please do not apply the current exceeding the breaking current to Micro Fuse.
- (6) Use Micro Fuse under the condition of category temperature.
- (7) Micro Fuse should not be used in the primary power source.

Micro Fuse should be selected by determining the operating conditions that will occur after final assembly, or estimating potential abnormalities through cycle testing.

2. Assembly and Mounting

During the entire assembly process, observe Micro Fuse body temperature and the heating time specified in the performance table. In addition,

- (1) Mounting and adjusting with soldering irons are not recommended since temperature and time control is difficult.
- In case of emergency for using soldering irons, be sure to observe the conditions specified in the performance table.
- (2) Micro Fuse body should not contact a soldering iron directly.
- (3) Once Micro Fuse mounted on the board, they should never be remounted on boards or substrates.
- (4) During mounting, be careful not to apply any excessive mechanical stresses to the Micro Fuse.

3. Solvents

For cleaning of Micro Fuse, immersion in isopropyl alcohol for 90 seconds (at 20 ~ 30°C liquid temp.) will not be damaged.

If organic solvents will be used to Micro Fuse, be sure to preliminarily check that the solvent will not damage Micro Fuse.

4. Ultrasonic Cleaning

Ultrasonic cleaning is not recommended for Micro Fuse. This may cause damage to Micro Fuse such as broken terminals which results in electrical characteristics effects, etc. depending on the conditions.

If Ultrasonic cleaning process must be used, please evaluate the effects sufficiently before use.

5. Caution During Usage

- (1) Micro Fuse with electricity should never be touched. Micro Fuse with electricity may cause burning due to Micro Fuse high temperature. Also, in case of touching Micro Fuse without electricity, please check the safety temperature of Micro Fuse.
- (2) Protective eyeglasses should always be worn when performing fusing tests. However, there is a fear that Micro Fuse will explode during test. During fusing tests, please cover particles not to fly outward from the board or testing fixture. Caution is necessary during usage at all times.

6. Environmental Conditions

- (1) Micro Fuse should not be stored or operated in the presence of acids, or alkalis, or corrosive atmosphere.
- (2) Micro Fuse should not be vibrated, shocked, or pressed excessively.
- (3) Micro Fuse should not be operated in a flammable or explosive atmosphere. (4) Please do not use Micro fuse in the environment where dew condensation occurs.
- In case Micro fuse has to be used under the dew condensation condition, please apply moisture-proof coating over Micro fuse.

Covering Micro fuse with moisture-proof coating may affect electrical characteristics, please evaluate the effects sufficiently before use.

7. Emergency

In case of fire, smoking, or offensive odor during operation, please cut off the power in the circuit or pull the plug out.

- (1) Micro Fuse should not be stored in an environment with high temperature, low temperature, high humidity, condensation and dust and avoid direct sunlight or corrosive atmosphere such as H₂S(hydrogen sulfide) or SO₂(sulfur dioxide).
 - Direct sunlight may cause decolorization and deformation of the exterior and taping.
 - Also, solderability will be remarkably lower in high humidity.
- (2) If the products are stored for an extended period of time, please contact Matsuo Sales Department for recommendation. The longer storage term causes packages and tapings to worsen. If the products will be stored for longer term, please contact us for advice.
- (3) The products in taping, package, or box should not be given any kind of physical pressure. Deformation of taping or package may affect automatic mounting.
- (4) The plastic reel (made of PS) used for packaging the product is intended for use in ambient temperatures (5-35°C). To prevent issues during automated insertion due to reel deformation or other factors, please keep the reel away from direct sunlight and heat sources, and ensure it does not reach high temperatures (above 60°C), including during transportation.

When Micro Fuse are disposed of as waste or "scrap", they should be treated as "industrial waste". Micro Fuse contain various kinds of metals and resins.

10. Samples

Micro Fuse received as samples should not be used in any products or devices in the market. Samples are provided for a particular purpose such as configuration, confirmation of electrical characteristics, etc.



MATSUO ELECTRIC CO., LTD.

Please feel free to ask our Sales Department for more information on Micro Fuse.

Overseas Sales 5-3,3-Chome, Sennari-cho, Toyonaka-shi, Osaka 561-8558, Japan Tel: 06-6332-0883 Fax: 06-6332-0920 5-3,3-Chome,Sennari-cho,Toyonaka-shi,Osaka 561-8558,Japan Tel:06-6332-0871 Fax:06-6331-1386 Head office

https://www.ncc-matsuo.co.jp/

Specifications on this catalog are subject to change without prior notice. Please inquire of our Sales Department to confirm specifications prior to use.

| 市場 | 適用用途 | | 用途 | 推奨品種 | 推奨品種 | 推奨品種 | 推奨品種 |
|--------------|------|---|--|---|--|--|-----------------------------------|
| 1172 | 分類 | 概要 | 代表的なアプリケーション例 | チップタンタルコンデンサ | リード付タンタルコンデンサ | 回路保護素子 | フィルムコンデンサ |
| 高信頼度 機器 | 1 | 高度な安全性や信頼性が要求される機器 製品の保守交換が不可能な機器、製品の故障が人命に 直接かかわる。または、致命的なシステムダウンを引 き起こす可能性がある機器 | の故障が人命に ・ 于田開羌機・高関連(衛星、ログット、人工衛星) | | 111型Pシリーズ | 該当なし | 該当なし |
| 車載 • 産業機器 | 2 | 信頼性が重視される機器 ・製品の保守交換が極めて困難な機器や、製品の故障が 人命に影響する、あるいは故障の範囲が広範囲である 機器 | ・自動車および鉄道・船舶等の輸送機器の車両制御 (エンジン制御、駆動制御、ブレーキ制御) ・新幹線・主要幹線の運行制御システム | 267型Nシリーズ 271型Nシリーズ 279型Mシリーズ | 111型Nシリーズ 111型Mシリーズ 112型Mシリーズ 204型Nシリーズ 247型 | JAG型Nシリーズ JAJ型Nシリーズ JAK型Nシリーズ JHC型Nシリーズ KAB型Nシリーズ KVA型Nシリーズ | 431型 431型Aシリーズ 503型 553型 |
| | 3 | 製品の保守交換が可能な機器や、製品の故障が人命に 影響しないが故障によるシステムダウンの損失が大き く保全管理が要求される機器 | ・エアコン、カーナビ等の車室内搭載部品、 車載用通信機器 ・家庭用/ビル用等のセキュリティ管理システム ・工業用ロボットや工作機械等の制御機器 | 267型Mシリーズ 267型Eシリーズ 281型Mシリーズ TCA型 | 204型Mシリーズ | KAB型Mシリーズ | 801型 802型 |
| 汎用機器 | 4 | ・ | | 251型Mシリーズ 281型Eシリーズ TCB型 | | JAE型、JAG型 JAJ型、JAK型 JHC型 KAB型 KAB型Tシリーズ KVA型 | 503型Aシリーズ |

| Market | Application classification | | Use | Recommendation Type | Recommendation Type | Recommendation Type | Recommendation Type |
|----------------------------|----------------------------|--|---|---|--|--|---|
| iviarket | by use | Outline | Typical example of application | Chip Tantalum Capacitors | Leaded Tantalum Capacitors | Circuit Protection Components | Film Capacitors |
| High reliability apparatus | 1 | Apparatus in which advanced safety and reliability are demanded. Whether fallure of the apparatus which cannot maintenance exchange products, and a product is direct for a human life, apparatus which changes or may cause a fatal system failure. | - Space development apparatus relation (Satellite, Rocket, Artificial Satellite) - Aviation and a defensive system - Atomic power, fire power, and a water-power generation system | Type 267 P Sereis | Type 111 P series | With no relevance | With no relevance |
| In-vehicle - | 2 | - Apparatus in which reliability is important The apparatus in which maintenance exchange of a product is very difficult, and failure of a product influence a human life, or the range of failure is wide range. | - Vehicles control of transport machines, such as a car, and a railroad, a vessel (Engine control, drive control, brake control) - The operation control system of the Shinkansen and a main artery | Type 267 N Sereis Type 271 N Sereis Type 279 M Sereis | Type 111 N series Type 111 M series Type 112 M series Type 204 N series Type 247 | Type JAG N series Type JAJ N series Type JAK N series Type JHC N series Type KAB N series Type KVA N series | Type 431 Type 431 A series Type 503 |
| Industrial apparatus | 3 | -Apparatus which can maintenance exchange products, and apparatus in which the loss of the system failure is large although failure of a product does not influence a human life, and maintenance engineering is demanded | | Type 267 M Sereis Type 267 E Sereis Type 281 M Sereis Type TCA | Type 204 M series | Type KAB M series | Type 553 Type 801 Type 802 |
| Apparatus in general | 4 | - The small size and the thin article which applies leading-edge technology positively - The product supposing being used widely in the market for the apparatus which can maintenance exchange products, and apparatus with a partial system failure by failure of product. | -Smart phone, Mobile phone, Mobile PC (tablet), Electronic dictionary - Desktop PC, Notebook PC, Home network - Amusement apparatus (Pachinko,Game machine) | Type 251M Series Type 281 E Series Type TCB | | Type JAE, Type JAG Type JAJ, Type JAK Type JHC Type KAB Type KAB T series Type KVA | Type 503 A series |

テーピング数量・リール寸法

Taping Quantity And Carrier Tape Dimensions

チップタンタルコンデンサ Chip Tantalum Capacitors

定格: 251型Mシリーズ, TCB型 Type: 251 M Series, TCB

| ケース記号 Case Code | ケースサイズ Case size | W (mm) | F (mm) | E (mm) | P ₁ (mm) | P ₂ (mm) | P ₀ (mm) | φD ₀ (mm) | 包装数/リール(個) Quantity/Reel (pcs) <i>ф</i> 180 |
|--------------------|---------------------|-----------|------------|-----------|------------------------|---------------------|------------------------|----------------------------------|---|
| U | 1.0×0.5 | | | | 2.0±0.05 | | | 1.55±0.03 | 10,000 |
| M | 1.6×0.8 | 8.0±0.3 | 2 5 , 0 05 | 1.75±0.1 | 4.0±0.1 | 2.0±0.05 | 4.0±0.1 | 1.5 ^{+0.1} ₀ | 4,000 / 3,000 ^{**1} |
| S | 2.0×1.25 | 0.0±0.3 | 3.5±0.05 | 1.75±0.1 | | | | | 3.000 |
| Α | 3.2×1.6 | | | | | | | | 3,000 |

※1. 251型500規格及びTCB型50規格は3000個/リール

Quantity per reel of Type 251 Specification Number 500 and Type TCB Specification Number 50 is 3000.

定格: 267型Mシリーズ, 267型Eシリーズ, 267型Pシリーズ, 271Nシリーズ 279型Mシリーズ, 281型Mシリーズ, 281型Eシリーズ

Type: 267 M Series, 267 E Series, 267 P Series, 271 N Series

279 M Series, 281 M Series, 281 E Series

| 21010 | 273 W Oches, 201 W Oches, 201 E Oches | | | | | | | | | |
|--------------------|---------------------------------------|-----------|---------------------|-----------|------------------------|---------------------|------------------------|-----------------------------------|-----------------------------------|------------|
| ケース記号 Case Code | | W (mm) | F (mm) | E (mm) | P ₁ (mm) | P ₂ (mm) | P ₀ (mm) | D ₀ (mm) | 包装数/リール(個) Quantity/Reel (pcs) | |
| Case Code | Odse size | (111111) | | | | | | | φ180 | ϕ 330 |
| Α | 3.2×1.6 | 8 0+0 3 | 0±0.3 3.5±0.05 1.75 | 1.75±0.1 | 4.0±0.1 | | | | 2,000 | 9,000 |
| В | 3.5×2.8 | 0.0±0.3 | | | | | | | | 8,000 |
| C3 | 6.0×3.2 | | 5.5±0.05 | | | 2.0±0.05 | 4.0±0.1 | φ1.5 ^{+0.1} ₀ | | 3,000 |
| D3 | 7.3×4.4 | 12.0±0.3 | 5.7±0.05 | 1.5±0.1 | 8.0±0.1 | 2.0±0.05 | 4.0±0.1 | Ψ1.5 0 | 500 | 2,500 |
| Н | 7.3×4.4 | 12.0±0.3 | 5.7±0.1 | 1.0±0.1 | 0.0E0.1 | | | | 500 | 1,500 |
| Е | 7.3×5.8 | | 5.5±0.05 | 1.75±0.05 | | | | | | 2,000 |

定格:267型Nシリーズ、TCA型 Type: 267 N Series, TCA

| 71 - 7 - | | | | | | | | | | |
|--------------------|---------------------|-----------|-------------------|-----------|------------------------|------------------------|------------------------|---------------------|-----------------------------------|-------|
| ケース記号 Case Code | ケースサイズ Case size | W (mm) | F (mm) | E (mm) | P ₁ (mm) | P ₂ (mm) | P ₀ (mm) | D ₀ (mm) | 包装数/リール(個) Quantity/Reel (pcs) | |
| | | | | | | | | | φ180 | φ330 |
| Α | 3.2×1.6 | 8.0±0.3 | 3.5±0.05 1.75±0.1 | 4.0±0.1 | 2.0±0.05 | 4.0±0.1 | φ1.5 ^{+0.1} 0 | 2,000 | 9,000 | |
| В | 3.5×2.8 | | | 1.75±0.1 | | | | | 8,000 | |
| С | 6.0×3.2 | 12.0±0.3 | 5.5±0.05 | | 8.0±0.1 | 2.0±0.05 | 4.0±0.1 | φ1.5 0 | 500 | 3,000 |
| D | 7.3×4.4 | | 5.7±0.05 | 1.5±0.1 | | | | | | 2,500 |

回路保護素子

Circuit Protection Components

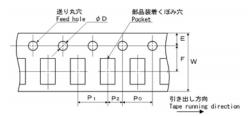
定格:JAE型、JAG型、JAG型Nシリーズ、JAJ型、JAJ型Nシリーズ、JAK型、JAK型Nシリーズ、JHC型、JHC型Nシリーズ KAB型、KAB型Nシリーズ、KAB型Mシリーズ、KAB型Tシリーズ、KVA型、KVA型Nシリーズ

Type: JAE, JAG, JAG N Series, JAJ, JAJ N Series, JAK, JAK N Series, JHC, JHC N Series

KAB, KAB N Series, KAB M Series, KAB T Series, KVA, KVA N Series

| ケース記号 Case Code | ケースサイズ Case size | W (mm) | | E (mm) | P ₁ (mm) | P ₂ | P ₀ (mm) | D ₀ | 包装数/リール(個) Quantity/Reel (pcs) | |
|--------------------|---------------------|-----------|----------|-----------|------------------------|----------------|---------------------|-----------------------------------|-----------------------------------|-------|
| Case Code | Case size | (111111) | (111111) | (111111) | (111111) | (mm) | (111111) | (mm) | φ180 | φ330 |
| 29 | 1.6×0.8 | | | 1.75±0.05 | | | | φ 1.55±0.03 | 5.000 | - |
| 31 | 2.0×1.25 | 8.0±0.3 | 3.5±0.05 | 1.7310.03 | 4.0±0.1 | | | ψ 1.33±0.03 | 3,000 | |
| 52 | 3.2×1.6 | | | | | 2.0±0.05 | 4.0±0.1 | φ1.5±0.1 | 2,000 | - |
| 44E | 7.3×5.8 | 12±0.3 | 5.5±005 | 1.75±0.1 | 8.0±0.1 | | | φ1.5 ^{+0.1} ₀ | 500 | 1,500 |
| 59F | 11.0×7.3 | 24±0.3 | 11.5±005 | | 12.0±0.1 | | | ψ 1.5 $^{\circ}$ $_{0}$ | - | 500 |





リール寸法/Reel dimensions

単位[mm] unit[mm] φ13 ±0.2 φ180又はφ330 (φ180 or φ330) ±0.8

チップタンタルコンデンサ テーピング形状記号

| Chip Tantalum Capacitors Tape code | | | | | | | | | |
|------------------------------------|-----------------------|-----------------------|--|--|--|--|--|--|--|
| φ180リール φ180Reel | φ3301/-1/ φ330Reel | 極性 Anode notation | | | | | | | |
| L | | 送り穴側 + Feed hole + | | | | | | | |
| R | | 送り穴側 - Feed hole - | | | | | | | |